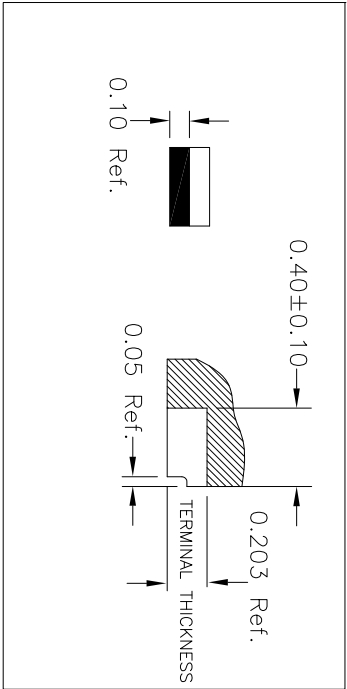
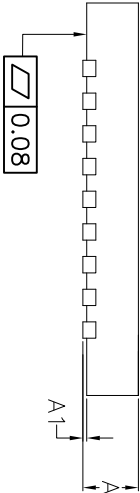
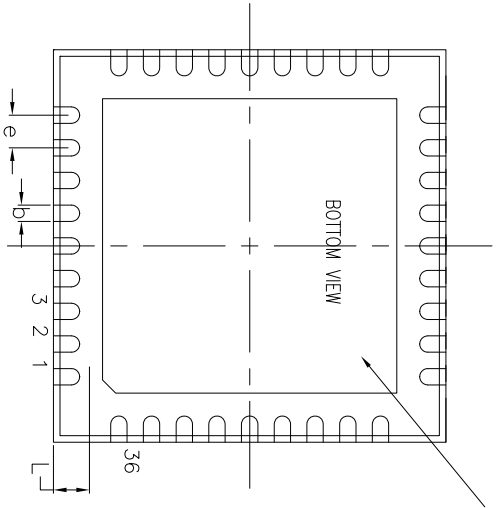
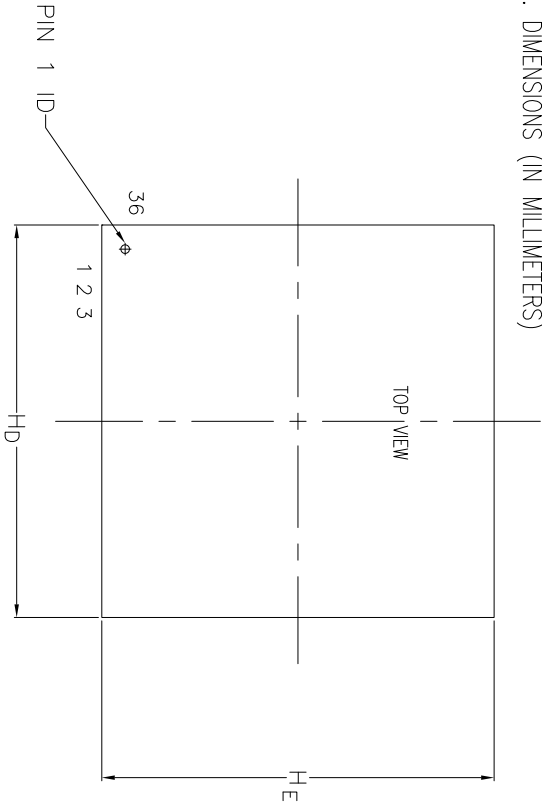


REVISIONS			
REV	DESCRIPTION	DATE	APPROVED
00	INITIAL RELEASE	2/23/16	JHUA

BASED ON JEDEC MO-220

1. DIMENSIONS (IN MILLIMETERS)



DIMENSIONS	min	nom
A	0.8	0.9
A1	0	0.05
b	0.2	0.3
e	0.5 nom	
H _b	5.9	6.1
H _E	5.9	6.1
L	0.30	0.50

2. WEIGHT
 3. PACKAGE BODY MATERIAL
 4. LEAD MATERIAL
 5. LEAD FINISH
- <0.1 g
 LOW STRESS EPOXY
 Cu-ALLOY
 SOLDER PLATING

TOLERANCES UNLESS SPECIFIED			
DECIMAL	ANGULAR	±	
XXX±			
XXXX±			
APPROVALS	DATE	TITLE	
DRAWN DAIG	2/23/16	NLC36 PACKAGE OUTLINE	
CHECKED		6.0 x 6.0 mm BODY , EPAD 4.5 x 4.5	
		0.50 mm PITCH QFN, WETTABLE FLANK	
SIZE	C	DRAWING No.	REV
		PSC-4648-02	00
DO NOT SCALE DRAWING			SHEET 1 OF 1

6024 Silver Creek Valley Rd
 San Jose, CA 95138
 PHONE: (408) 727-6116
 FAX: (408) 492-8674

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